Preferred Devices

Dual Common Emitter Bias Resistor Transistors

PNP Silicon Surface Mount Transistors with Monolithic Bias Resistor Network

The BRT (Bias Resistor Transistor) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base-emitter resistor. These digital transistors are designed to replace a single device and its external resistor bias network. The BRT eliminates these individual components by integrating them into a single device. In the UMC2NT1 series, two BRT devices are housed in the SOT-353 package which is ideal for low power surface mount applications where board space is at a premium.

- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- Available in 8 mm, 7 inch/3000 Unit Tape and Reel

MAXIMUM RATINGS ($T_A = 25^{\circ}$ C unless otherwise noted, common for Q_1 and Q_2 , – minus sign for Q_1 (PNP) omitted)

Rating	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	50	Vdc
Collector-Emitter Voltage	V _{CEO}	50	Vdc
Collector Current	Ic	100	mAdc

THERMAL CHARACTERISTICS

Thermal Resistance – Junction-to-Ambient (surface mounted)	$R_{\theta JA}$	833	°C/W
Operating and Storage Temperature Range	T _J , T _{stg}	-65 to +150	°C
Total Package Dissipation @ T _A = 25°C (Note 1.)	P _D	150	mW

DEVICE MARKING AND RESISTOR VALUES

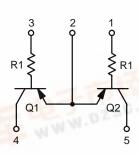
Device	Marking	R1 (K)	R2 (K)
UMA4NT1	U0	10	∞
UMA6NT1	U1	47	∞

^{1.} Device mounted on a FR-4 glass epoxy printed circuit board using the minimum recommended footprint.



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SC-88A/SOT-353 CASE 419A STYLE 7

MARKING DIAGRAM



Ux = Device Marking

x = 0 or 1

d = Date Code

ORDERING INFORMATION

Device	Package	Shipping [†]
UMA4NT1	SOT-323	3000/Tape & Reel
UMA6NT1	SOT-323	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.



ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•		•	•	
Collector-Base Cutoff Current (V _{CB} = 50 V, I _E = 0)	I _{CBO}	-	-	100	nAdc
Collector-Emitter Cutoff Current (V _{CB} = 50 V, I _B = 0)	I _{CEO}	_	-	500	nAdc
Emitter-Base Cutoff Current UMA4NT1 $(V_{EB} = 6.0, I_C = 5.0 \text{ mA})$ UMA6NT1	I _{EBO}	- -	_ _	0.9 0.2	mAdc
ON CHARACTERISTICS					
Collector-Base Breakdown Voltage ($I_C = 10 \mu A, I_E = 0$)	V _{(BR)CBO}	50	-	_	Vdc
Collector-Emitter Breakdown Voltage (I _C = 2.0 mA, I _B = 0)	V _{(BR)CEO}	50	-	_	Vdc
DC Current Gain UMA4NT1 (V _{CE} = 10 V, I _C = 5.0 mA) UMA6NT1	h _{FE}	160 160	250 250	- -	
Collector–Emitter Saturation Voltage (I _C = 10 mA, I _B = 0.3 mA)	V _{CE(SAT)}	_	-	0.25	Vdc
Output Voltage (on) (V _{CC} = 5.0 V, V _B = 2.5 V, R _L = 1.0 k Ω)	V _{OL}	_	-	0.2	Vdc
Output Voltage (off) (V _{CC} = 5.0 V, V _B = 0.5 V, R _L = 1.0 k Ω)	V _{OH} 4.9 – –		_	Vdc	
Input Resistor UMA4NT1 UMA6NT1	R1	7.0 33	10 47	13 61	kΩ

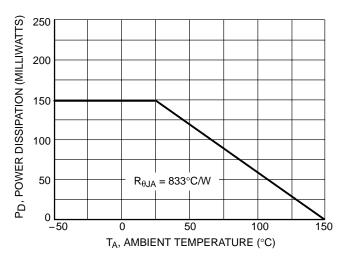


Figure 1. Derating Curve

TYPICAL ELECTRICAL CHARACTERISTICS – UMA4NT1

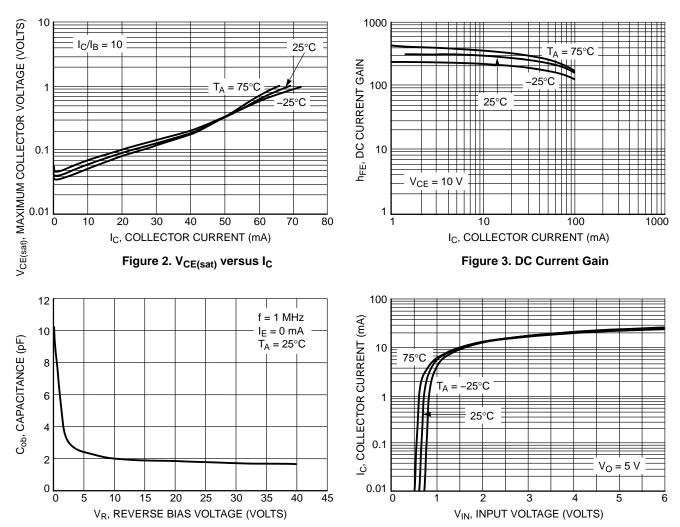
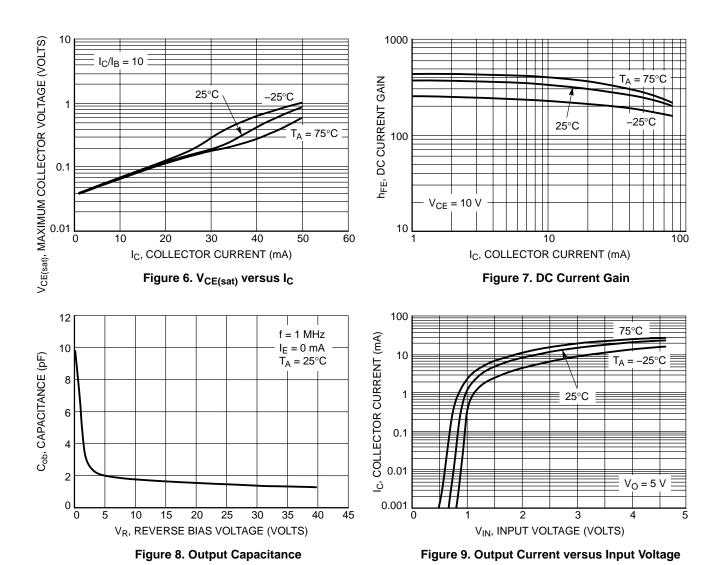


Figure 4. Output Capacitance

Figure 5. Output Current versus Input Voltage

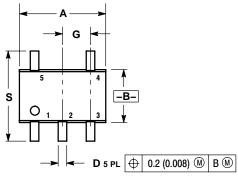
TYPICAL ELECTRICAL CHARACTERISTICS – UMA6NT1

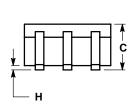


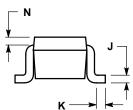
PACKAGE DIMENSIONS

SC-88A/SOT-353

5-LEAD PACKAGE CASE 419A-02 ISSUE G





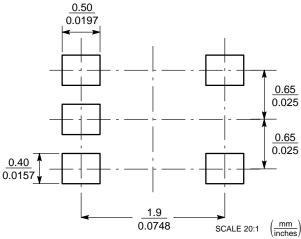


- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. 419A-01 OBSOLETE. NEW STANDARD 419A-02.
 4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	INCHES		MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.071	0.087	1.80	2.20	
В	0.045	0.053	1.15	1.35	
С	0.031	0.043	0.80	1.10	
D	0.004	0.012	0.10	0.30	
G	0.026	0.026 BSC		0.65 BSC	
Н		0.004		0.10	
J	0.004	0.010	0.10	0.25	
K	0.004	0.012	0.10	0.30	
N	0.008 REF		0.20	REF	
S	0.079	0.087	2.00	2.20	

- STYLE 7: PIN 1. BASE 2. EMITTER 3. BASE 4. COLLECTOR 5. COLLECTOR

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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